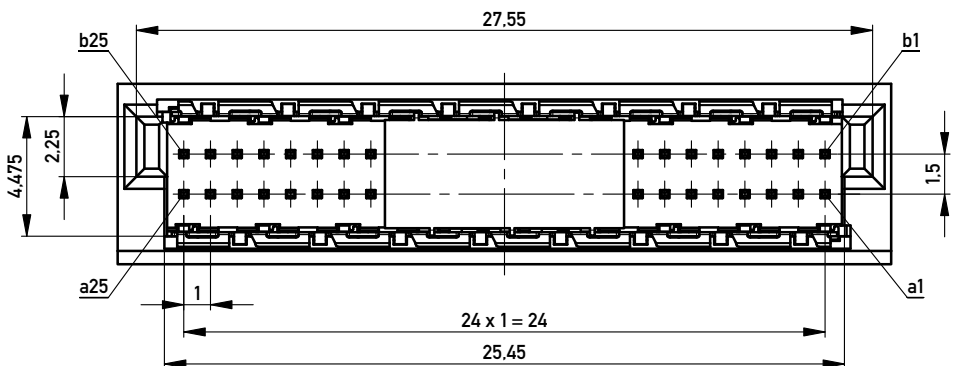
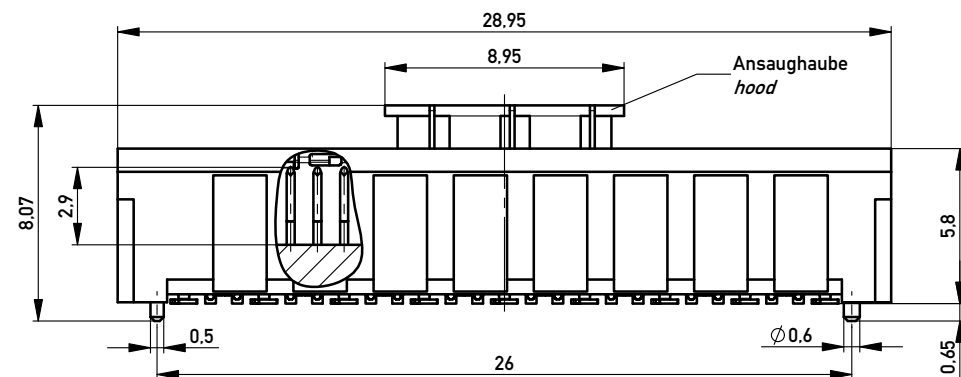
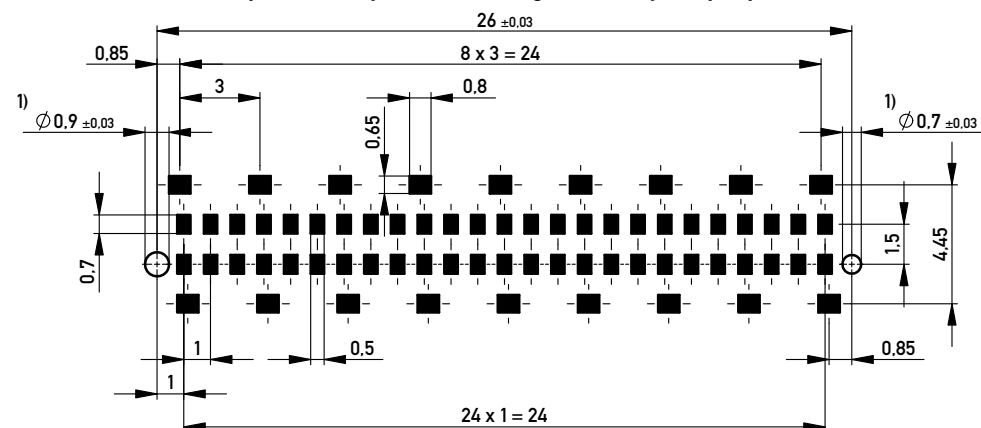
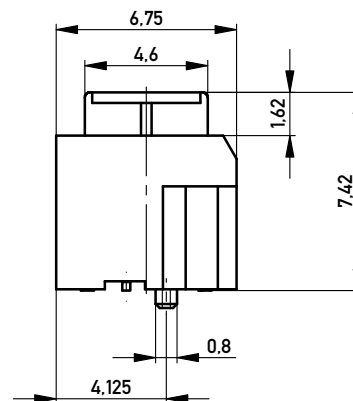




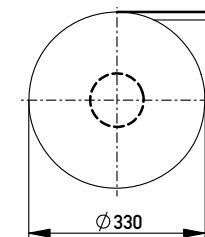
Leiterplatten-Layout Vorschlag / PCB-layout proposal



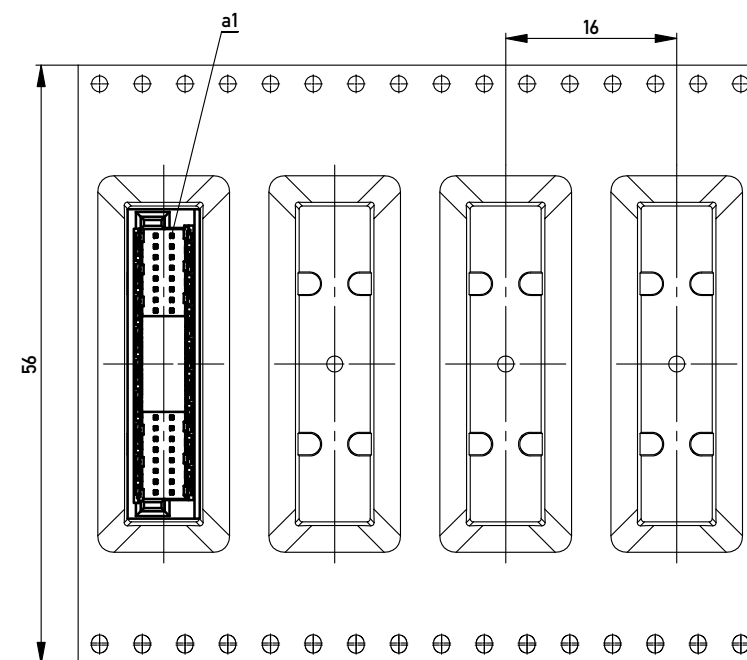
1) Durchmesser des Bohrers / drill tool



Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 400 Stück
Packaging unit: 400 pcs



Abspulrichtung - Reel off Direction



Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Information:			Tolerances			Scale	5:1		
					All Dimensions in mm				
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						M02 MSpeed Blind Mate 50 SMD			
			www.ERNI.com			354183			I
									A3
e		28.01.2014							
Index		Date							
					Class		MSPEED		

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